

### **DATASHEET**

### **DESCRIPTION**

Microsemi's PD69108 Power over Ethernet (PoE) Manager integrates power, analog and state of the art logic into a single 48 pin, plastic QFN package. The device is used in Ethernet switches and Midspans, enabling network devices to share power and data over the same cable.

The PD69108 device is an 8 ports, mixed-signal, high-voltage PoE driver. It enables detection of IEEE802.3at-2009 compliant Type 1 and Type 2 PDs (Powered Devices), ensuring safe power feeding and disconnection of ports with full digital control and a minimum of external components.

The PD69108 executes all real time functions as specified in the IEEE802.3af-2003 ("AF") and IEEE802.3at-2009 High Power ("AT") standards, including load detection and "AF" and "AT" classification. In addition, the PD69108 features Multiple Classification Attempts (MCA) port status monitoring, and provides system level activities such as power management and MIB support for system management.

The PoE device is designed to detect and disable disconnected ports utilizing DC disconnection methods, as specified in the IEEE 802.3af-2003 and IEEE802.3at-2009 standards.

The unit provides PD protection such as over-load, under-load, over-voltage and short-circuiting. It supports supply voltages ranging from 44 to 57 VDC with no need for additional power supply sources. The chip includes built-in internal thermal protection.

Optionally, the PD69108 can detect legacy/pre-standard PD devices.

The PD69108 is a low power device using an internal MOSFET and an external 0.36  $\Omega$  sense resistor.

### **KEY FEATURES**

- IEEE802.3af-2003 compliant
- IEEE802.3at-2009 compliant, including two-event classification
- Supports pre-standard PD detection
- Supports Cisco devices detection
- Single DC voltage input (44 to 57 VDC)
- Input voltage out of range protection
- Wide temperature range: -10°C to +85°C
- PD69108F version covering -40°C to +85°C
- Over-temperature protection
- Low power dissipation (0.36 Ω sense resistor and 0.3Ω MOSFET Rdson)
- Includes Reset command pin
- 4 x direct address configuration pins
- Continuous port monitoring and system data
- Configurable load current setting
- Configurable AT/AF modes
- Configurable standard and legacy detection mode
- Power soft start mechanism
- On-chip thermal protection
- Voltage monitoring/protection
- Built in 3.3 VDC and 5 VDC regulators
- Internal power on reset
- RoHS compliant
- Emergency power management supporting four configurable power bank I/Os
- Can be cascaded to up to 12 PoE devices (96 ports)

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com



|                                | PACKAGE ORDER INFO                               | THERMAL DATA   |
|--------------------------------|--|--|
| Plastic 48 pin QFN 8 mm x 8 mm |  | TYPICAL THERMAL RESISTANCE-JUNCTION TO AMBIENT 25° C/W   |
| T <sub>A</sub> (°C)            | RoHS compliant / Pb-free/MSL1                    | TYPICAL THERMAL RESISTANCE-JUNCTION TO CASE 4° C/W       |
| -10 to +85                     | PD69108ILQ                                       | Junction Temperature Calculation:                        |
| -40 to +85                     | PD69108FILQ                                      | $T_{J} = T_{A} + (P_{D} \times \theta_{JA}).$            |
| Note: Availab                  | ole in Tape and Reel. Append the letters "TR" to | The $\theta_{JA}$ numbers are guidelines for the thermal |
| the part numb                  | ber.   | performance of the device/pc-board system. All of the    |
|                                |  | above assume no ambient airflow.                         |

#### **POWER DISSIPATION**

Rsense Power Dissipation:  $0.36 \Omega \times 10^{-2}$ Rds\_ON Power Dissipation: 0.3Ω x Iport<sup>2</sup>

• Pport\_AF = 15.4 W ==> PRsense = 28.2mW

PRds ON = 23.4mW

Pport\_AT = 30 W ==> PRsense = 107 mW PRds ON = 88.5 mW

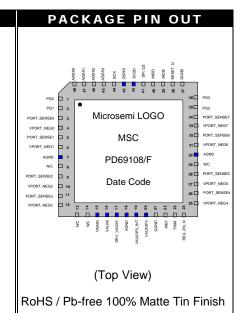
Calculated for Supply input Voltage of 55V

| INTERNAL 3.3V VOLTAGE REGULATOR IS USED  | EXTERNAL 3.3V VOLTAGE REGULATOR IS   |
|--|--|
|  | USED   |
| PD69108 self power dissipation: 1.1 W  | PD69108 self power dissipation: 0.5 W  |
| PD69108 8 ports AF Application Power dissipation = 1.1 W + [8 x (28.2 mW + 23.4mW)] = 1.51W  | PD69108 AF 8 ports Application Power dissipation = 0.5 W + [ 8 x (28.2mW + 23.4mW) ] = 0.91W |
| PD69108 8 ports AT Application Power dissipation = 1.1 W + [ 8 x (107 mW + 88.5mW) ] = 2.66W | PD69108 8 ports AT Application Power dissipation = 0.5 W + [ 8 x (107 mW + 88.5mW) ] = 2.06W |

| ABSOLUTE MAXIMUM  | RATINGS                                  |
|---|--|
| Supply Input Voltage (V <sub>MAIN</sub> )   | -0.3 to 74 VDC                           |
| Port_Neg[07] Pins   | -0.3 to 74 VDC                           |
| Port_Sense[07] Pins   | -0.3 to 3.6 VDC                          |
| QGND, GND Pins  | -0.3 to 0.3 VDC                          |
| All Other Pins  | -0.3 to 3.6 VDC                          |
| PD69108 Operating Ambient Temperature Range   | -10° to +85° C                           |
| PD69108F Operating Ambient Temperature Range  | -40° to +85° C                           |
| Maximum Operating Junction Temperature ESD Protection at all I/O Pins Storage Temperature Range | +150° C<br>± 2 KV HBM<br>-65° to +150° C |
| Otorago Tomporataro Italigo   | -00 10 <del>1</del> 100 C                |

### Notes:

Exceeding these ratings can cause damage to the device. All voltages are with respect to ground. Currents are marked positive when flowing into specified terminals and marked negative when flowing out of a specified terminal.





#### **DATASHEET**

### ROHS AND SOLDER REFLOW INFORMATION

RoHS 6/6

Pb-free 100% Matte Tin Finish

Package Peak Temperature for Solder Reflow

260°C (+0°C, -5°C)

(40 seconds maximum exposure)

#### Notes:

Exceeding these ratings can cause damage to the device.

IPC/JEDEC J-STD-020C July 2004

Table 5-2 Classification Reflow Profiles

| Profile Feature   | Sn-Pb Eutectic Assembly            | Pb-Free Assembly                   |
|---|------------------------------------|------------------------------------|
| Average Ramp-Up Rate<br>(Ts <sub>max</sub> to Tp)   | 3 °C/second max.                   | 3° C/second max.                   |
| Preheat  - Temperature Min (Ts <sub>min</sub> )  - Temperature Max (Ts <sub>max</sub> )  - Time (ts <sub>min</sub> to ts <sub>max</sub> ) | 100 °C<br>150 °C<br>60-120 seconds | 150 °C<br>200 °C<br>60-180 seconds |
| Time maintained above:  - Temperature (T <sub>L</sub> )  - Time (t <sub>L</sub> )   | 183 °C<br>60-150 seconds           | 217 °C<br>60-150 seconds           |
| Peak/Classification Temperature (Tp)  | See Table 4.1                      | See Table 4.2                      |
| Time within 5 °C of actual Peak<br>Temperature (tp)   | 10-30 seconds                      | 20-40 seconds                      |
| Ramp-Down Rate  | 6 °C/second max.                   | 6 °C/second max.                   |
| Time 25 °C to Peak Temperature  | 6 minutes max.                     | 8 minutes max.                     |

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

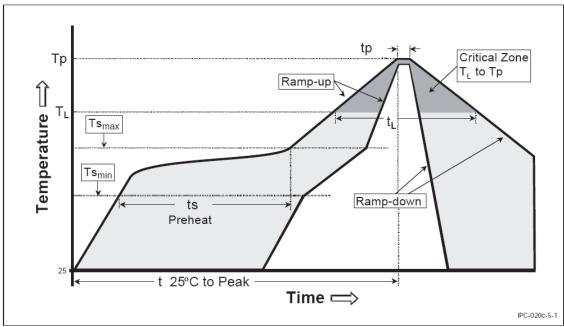


Figure 5-1 Classification Reflow Profile

Table 4-2 Pb-free Process - Package Classification Reflow Temperatures

| Package<br>Thickness |             |             | Volume mm <sup>3</sup> >2000 |
|----------------------|-------------|-------------|------------------------------|
| <1.6 mm              | 260 +0 °C * | 260 +0 °C * | 260 +0 °C *                  |
| 1.6 mm - 2.5 mm      | 260 +0 °C * | 250 +0 °C * | 245 +0 °C *                  |
| ≥2.5 mm              | 250 +0 °C * | 245 +0 °C * | 245 +0 °C *                  |

Tolerance: The device manufacturer/supplier shall assure process compatibility up to and including the stated classification temperature (this means Peak reflow temperature +0 °C. For example 260 °C+0°C) at the rated MSL level.



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### **ELECTRICAL CHARACTERISTICS**

Unless otherwise specified, the following specifications apply to the operating ambient temperature.

| PARAMETER                                | SYMBOL                        | TEST CONDITIONS /  | PD69108 POE<br>MANAGER |     |      | UNITS           |
|--|-------------------------------|--|------------------------|-----|------|-----------------|
| FARAMETER                                | STWBOL                        | COMMENT  |                        | TYP | MAX  | UNITS           |
| POWER SUPPLY                             |                               | '  |                        |     |      |                 |
| Input Voltage                            | V <sub>MAIN</sub>             | Supports Full IEEE802.3 functionality                                | 44                     | 55  | 57   | V               |
| Power Supply Current  @ Operating Mode   |                               | V <sub>MAIN</sub> = 55 VDC   |                        |     | 20   | mA              |
| 5V Output Voltage                        | V <sub>AUX5</sub>             |  | 4.5                    | 5   | 5.5  | V <sub>DC</sub> |
| 3.3V Output Voltage                      | V <sub>AUX3P3</sub>           |  | 2.97                   | 3.3 | 3.63 | V <sub>DC</sub> |
|  |                               | Without external NPN   |                        |     | 5    | mA              |
| 3.3V Output Current                      |                               | With external NPN transistor on VAUX5                                |                        |     | 30   | mA              |
| 3.3V Input Voltage                       | V <sub>AUX3P3</sub>           | REG_EN_N pin = 3.3V<br>(internal reg. is disabled)<br>VAUX3P3_INT=5V | 3                      | 3.3 | 3.6  | V <sub>DC</sub> |
| DIGITAL I/O (RES                         | SET_N, MISO, MOS              | I, SCK, CS, PG[03], ADD[   | 03])                   |     |      |                 |
| Input Logic High<br>Threshold            | V <sub>IH</sub>               |  | 2.2                    |     |      | V               |
| Input Logic Low<br>Threshold             | V <sub>IL</sub>               |  |                        |     | 0.8  | V               |
| Input Hysteresis Voltage                 |                               |  | 0.4                    | 0.6 | 0.8  | V               |
| Input High Current                       | I <sub>IH</sub>               |  | -10                    |     | 10   | uA              |
| Input Low Current                        | I <sub>IL</sub>               |  | -10                    |     | 10   | uA              |
| Output High Voltage                      | V <sub>OH</sub>               | For I <sub>OH</sub> = -1 mA  | 2.4                    |     |      | V               |
| Output Low Voltage                       | V <sub>OL</sub>               | $I_{OH} = 1 \text{ mA}$  |                        |     | 0.4  | V               |
| POE LOAD<br>Currents                     |                               |  |                        |     |      |                 |
| AF Limit Mode                            | AF_LIM                        |  | 400                    | 425 | 450  | mA              |
| AT Limit                                 | AT_LIM                        |  | 775                    | 850 | 925  | mA              |
| AT Limit Dynamic<br>Range                | Configurable by communication | $R_{SENSE}$ = 0.36 $\Omega$ 1% connected at Port_Sense pin           | 540                    |     | 1200 | mA              |
| MAIN POWER SWITCHING FET                 |                               |  |                        |     |      |                 |
| On Resistance                            | R <sub>DSON</sub>             |  |                        | 0.3 |      | Ω               |
| Internal Thermal<br>Protection Threshold |                               |  |                        | 200 |      | °C              |



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# **Dynamic Characteristics**

The PD69108 utilizes three current level thresholds ( $I_{min}$ ,  $I_{cut}$ ,  $I_{lim}$ ) and three timers ( $T_{min}$ ,  $T_{cut}$ ,  $T_{lim}$ ).

- Loads that consume I<sub>lim</sub> current for more than T<sub>lim</sub> are classified as being in 'short circuit state' and are shutdown.
- Loads that dissipate more than  $I_{\text{cut}}$  for longer than  $T_{\text{cut}}$  are classified as 'overloads' and are automatically shutdown.
- If output power is below  $I_{min}$  for more than  $T_{min}$ , the PD is classified as 'no-load' and is shutdown.

Automatic recovery from over-load condition is attempted every T<sub>OVLREC</sub> periods (typically 1 second). Output power is limited to I<sub>lim.</sub> which is a maximum peak current allowed at the port.

### **IEEE802.3 AF Mode Parameters**

| PARAMETER  |   | CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|--|---|--|------|------|------|------|
| Automatic recovery from no-<br>load shutdown     | T <sub>UDLREC</sub> value, measured from port shutdown point (can be modified through control port) |  |      | 1    |      | Sec  |
| Cutoff timers accuracy                           | Typical   | accuracy of T <sub>cut</sub>   |      | 2    |      | ms   |
| Inrush current                                   | I <sub>Inrsh</sub>  | For $t = 50$ ms, $C_{load} = 180$ uF max.  | 400  |      | 450  | mA   |
| Output current operating range                   | I <sub>port</sub>   | Continuous operation after startup period.   | 10   |      | 350  | mA   |
| Output power available operating range           | P <sub>port</sub>   | Continuous operation after startup period, at port output.   | 0.57 |      | 15.4 | W    |
| Off mode current                                 | I <sub>min1</sub>   | Must disconnect for T greater than T <sub>UVL</sub>  | 0    |      | 5    | mA   |
|  | I <sub>min2</sub>   | May or may not disconnect where T is greater than T <sub>UVL</sub>   | 5    | 7.5  | 10   | mA   |
| PD power maintenance request drop-out time limit | $T_{PMDO}$  | Buffer period to handle transitions  | 300  |      | 400  | ms   |
| Over-load current detection range                | I <sub>cut</sub>  | Time limited to T <sub>OVL</sub>   | 350  |      | 400  | mA   |
| Over load time limit                             | T <sub>OVL</sub>  |  | 50   |      | 75   | ms   |
| Turn on rise time                                | T <sub>rise</sub>   | From 10% to 90% of $V_{port}$ (Specified for PD load consisting of 100 uF capacitor in parallel to 200 $\Omega$ ). | 15   |      |      | us   |
| Turn off time                                    | T <sub>off</sub>  | From V <sub>port</sub> to 2.8 VDC  |      |      | 500  | ms   |
| Time maintain power signature                    | T <sub>MPS</sub>  | DC modulation time for DC disconnect   |      | 49   |      | ms   |



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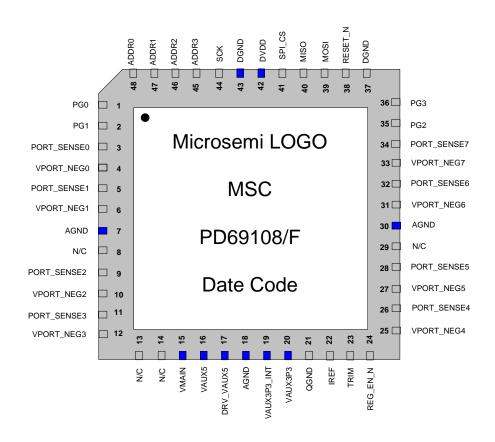
### **IEEE802.3 AT Mode Parameters**

| PARAMETER  |                    | CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|--|--------------------|--|------|------|------|------|
| Automatic recovery from no-load shutdown         |                    | value, measured from port shutdown an be modified through control port)  |      | 1    |      | S    |
| Cutoff timers accuracy                           | Typical            | accuracy of T <sub>cut</sub>   |      | 2    |      | ms   |
| Inrush current                                   | I <sub>Inrsh</sub> | For t = 50 ms, Cload = 180 uF max.   | 400  |      | 450  | mA   |
| Output current operating range                   | I <sub>port</sub>  | Continuous operation after startup period  | 10   |      | 600  | mA   |
| Output power available, operating range          | P <sub>port</sub>  | Continuous operation after startup period at port output   | 0.57 |      | 36   | W    |
| Off mode current                                 | I <sub>min1</sub>  | Must disconnect where T is greater than T <sub>UVL</sub>   | 0    |      | 5    | mA   |
|  | I <sub>min2</sub>  | May or may not disconnect where T is greater than T <sub>UVL</sub>   | 5    | 7.5  | 10   | mA   |
| PD power maintenance request drop-out time limit | T <sub>PMDO</sub>  | Buffer period to handle transitions  | 300  |      | 400  | ms   |
| Over-load current detection range                | I <sub>cut</sub>   | Time limited to T <sub>OVL</sub>   | 600  |      | 775  | mA   |
| Over-load time limit                             | T <sub>OVL</sub>   |  | 50   |      | 75   | ms   |
| Turn on rise time                                | T <sub>rise</sub>  | From 10% to 90% of $V_{port}$ (Specified for PD load consisting of 100 uF capacitor in parallel to 200 $\Omega$ ). | 15   |      |      | us   |
| Turn off time                                    | Toff               | From V <sub>port</sub> to 2.8 VDC  |      |      | 500  | ms   |
| Time maintain power signature                    | TMPS               | DC modulation time for DC disconnect   |      | 49   |      | ms   |



### **DATASHEET**

### **Package Pinout**



PD69108 for -10° to +85°C Operating Ambient Temperature Range PD69108F for -40° to +85°C Operating Ambient Temperature Range

### **Detailed Pinout Description**

| PIN | PIN NAME    | PIN TYPE      | DESCRIPTION   |
|-----|-------------|---------------|---|
| 0   | Exposed PAD | Analog Gnd    | Exposed PAD: Metal plate on the IC bottom side connected to analog ground.  A decent ground plane (about 500 mil inch over 500 mil inch) should be deployed around this pin whenever possible |
| 1   | PG0         | Digital Input | Power supply monitoring   |
| 2   | PG1         | Digital Input | Power supply monitoring   |
| 3   | PORT_SENSE0 | Analog Input  | Sense resistor port input (Connected to 0.36 $\Omega$ , 1% resistor to QGND with ~12 m $\Omega$ trace for measurements accuracy).   |
| 4   | VPORT_NEG0  | Analog I/O    | Negative port output  |
| 5   | PORT_SENSE1 | Analog Input  | Sense resistor port input (Connected to 0.36 $\Omega$ , 1% resistor to QGND with ~12 m $\Omega$ trace for measurements accuracy).   |
| 6   | VPORT_NEG1  | Analog I/O    | Negative port output  |



### **DATASHEET**

| PIN | PIN NAME    | PIN TYPE     | DESCRIPTION   |
|-----|-------------|--------------|---|
| 7   | AGND        | Power        | Analog ground   |
| 8   | N/C         |              | Not Connected   |
| 9   | PORT_SENSE2 | Analog Input | Sense resistor port input (Connected to 0.36 $\Omega$ , 1% resistor to QGND with ~12 m $\Omega$ trace for measurements accuracy).   |
| 10  | VPORT_NEG2  | Analog I/O   | Negative port output  |
| 11  | PORT_SENSE3 | Analog Input | Sense resistor port input (Connected to 0.36 $\Omega$ , 1% resistor to QGND with ~12 m $\Omega$ trace for measurements accuracy).   |
| 12  | VPORT_NEG3  | Analog I/O   | Negative port output  |
| 13  | N/C         | Analog I/O   | Test pin for production use only  |
| 14  | N/C         | Analog I/O   | Keep open, not connected  |
| 15  | VMAIN       | Power        | Supplies voltage for the internal analog circuitry. A low ESR 1 uF (or higher) bypass capacitor, connected to AGND should be placed as close as possible to this pin through low resistance traces.   |
| 16  | VAUX5       | Power        | Regulated 5 VDC output voltage source; it needs to be connected to a filtering capacitor of 4.7 uF or higher.  If an external NPN is used to regulate the voltage, connect this pin to the "Emitter" (the "collector" should be connected to Vmain) |
| 17  | DRV_VAUX5   | Power        | Driven outputs for 5 VDC external regulation; if internal regulation is used, connect to pin 16. If an external NPN is used to regulate the voltage, connect this pin to the "Base".  |
| 18  | AGND        | Power        | Analog ground   |
| 19  | VAUX3P3_INT | Power        | Connected to VAX3P3 (pin 20) if internal 3.3 VDC regulator is used. Connect to VAUX5 (pin 16) if external 3.3 VDC regulator is used   |
| 20  | VAUX3P3     | Power        | Regulated 3.3v output voltage source. A 4.7 µF or higher filtering capacitor should be connected between this pin and AGND. When an external 3.3 VDC regulator is used, connect it to this pin to supply the chip.                                  |
| 21  | QGND        | Power        | Quiet analog ground.  |
| 22  | IREF        | Analog Input | Reference resistor pin. Connect a 30.1 kΩ 1% resistor to QGND.  |
| 23  | TRIM        | Analog Input | Trimming Input for IC production. Should be connected to VAUX3P3.   |
| 24  | REG_EN_N    | REG_EN_N     | Enable/Disable the internal 3.3 VDC regulator in case an external 3.3 VDC is used to supply the chip.  • GND: Internal regulator enabled  • 3.3 VDC: Internal regulator disabled  |
| 25  | VPORT_NEG4  | Analog I/O   | Negative port output.   |
| 26  | PORT_SENSE4 | Analog Input | Sense resistor port input (Connected to 0.36 $\Omega$ , 1% resistor to QGND with ~12 m $\Omega$ trace for measurements accuracy).   |
| 27  | VPORT_NEG5  | Analog I/O   | Negative port output.   |
| 28  | PORT_SENSE5 | Analog Input | Sense resistor port input. (Connected to 0.36 $\Omega$ , 1% resistor to QGND with ~12 m $\Omega$ trace for measurements accuracy).  |
| 29  | N/C         |              | Not Connected   |
| 30  | AGND        | Power        | Analog ground.  |
| 31  | VPORT_NEG6  | Analog I/O   | Negative port output.   |

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### **DATASHEET**

| PIN | PIN NAME    | PIN TYPE       | DESCRIPTION  |
|-----|-------------|----------------|--|
| 32  | PORT_SENSE6 | Analog Input   | Sense resistor port input. (Connected to 0.36 $\Omega$ , 1% resistor to QGND with ~12 m $\Omega$ trace for measurements accuracy). |
| 33  | VPORT_NEG7  | Analog I/O     | Negative port output.  |
| 34  | PORT_SENSE7 | Analog Input   | Sense resistor port input. (Connected to 0.36 $\Omega$ , 1% resistor to QGND with ~12 m $\Omega$ trace for measurements accuracy). |
| 35  | PG2         | Digital Input  | Power supply monitoring.   |
| 36  | PG3         | Digital Input  | Power supply monitoring.   |
| 37  | TST         | Digital I/O    | Test pin for production use only. Keep connected to DGND.  |
| 38  | RESET_N     | Digital Input  | Reset input; active low ('0' = reset) An external 10K pull-up resistor should be connected between this pin and DVDD.              |
| 39  | MOSI        | Digital Input  | SPI bus, Master Data out/slave in  |
| 40  | MISO        | Digital Output | SPI bus, Master Data in/slave out  |
| 41  | SPI_CS      | Digital Input  | SPI bus, Chip Select   |
| 42  | DVDD        | Power          | Digital 3.3 V input. It needs to be connected to filtering capacitor of 1 uF.  |
| 43  | DGND        | Digital I/O    | Digital GND  |
| 44  | SCK         | Digital Input  | SPI bus, Serial clock input  |
| 45  | ADDR3       | Digital Input  | Address bus to set SPI address   |
| 46  | ADDR2       | Digital Input  | Address bus to set SPI address   |
| 47  | ADDR1       | Digital Input  | Address bus to set SPI address   |
| 48  | ADDR0       | Digital Input  | Address bus to set SPI address   |

### Address Pin Description (ADDR<3:0>)

| ADDR3 | ADDR2 | ADDR1 | ADDRO | SPI ADDRESS [HEX]        |
|-------|-------|-------|-------|--------------------------|
| 0     | 0     | 0     | 0     | 0                        |
| 0     | 0     | 0     | 1     | 1                        |
| 0     | 0     | 1     | 0     | 2                        |
| 0     | 0     | 1     | 1     | 3                        |
| 0     | 1     | 0     | 0     | 4                        |
| 0     | 1     | 0     | 1     | 5                        |
| 0     | 1     | 1     | 0     | 6                        |
| 0     | 1     | 1     | 1     | 7                        |
| 1     | 0     | 0     | 0     | 8                        |
| 1     | 0     | 0     | 1     | 9                        |
| 1     | 0     | 1     | 0     | Α                        |
| 1     | 0     | 1     | 1     | В                        |
| 1     | 1     | 0     | 0     | С                        |
| 1     | 1     | 0     | 1     | D                        |
| 1     | 1     | 1     | 0     | E – Broadcast (See note) |
| 1     | 1     | 1     | 1     | F                        |

• '1' = DVDD (3.3 V)

Rev. 1.6

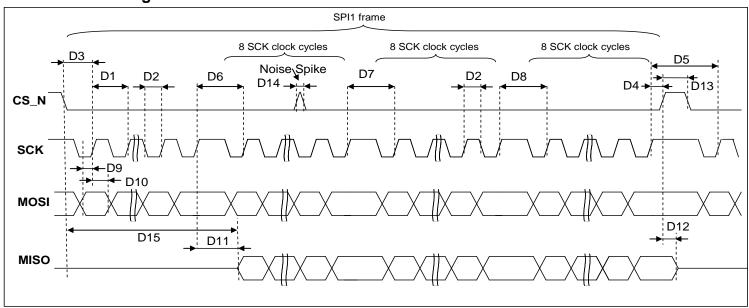
'0' = DGND (digital ground)

Note: This address is used for Broadcast. Do not set any PD69108s in the system to this address.



### **DATASHEET**

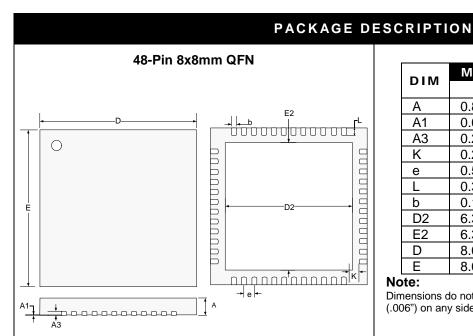
## **SPI Detailed Timing Information**



| Name | Min Delay                     | Max Delay                 | Description  |
|------|-------------------------------|---------------------------|--|
| D1   |                               | 714ns                     | SPI clock period   |
| D2   | 45                            | 55 SPI duty cycle         |  |
| D3   | 340 ns                        |                           | SPI_CS setup to SPI clock Positive Edge (delay after SPI_CS active signal)   |
| D4   | 340 ns                        |                           | SPI_CS hold to SPI clock Positive Edge (delay before SPI_CS inactive Signal) |
| D5   | 2 spi clock cycles            |                           | Delay between last SCK in eSPI1 frame and first SCK at adjacent eSPI1 frame  |
| D6   | 1 spi clock cycles            |                           | Between byte 0 (IC addr) and byte 1(addr)                                    |
| D7   | 1 spi clock cycles            |                           | Between byte 1 (addr) and byte 2(data).                                      |
| D8   | 1 SPI clock cycles            |                           | Between byte 2 (MS data byte) and byte 3(LS data byte).                      |
| D9   | 340 ns                        |                           | MOSI setup time  |
| D10  | 210 ns                        |                           | MOSI hold time   |
| D11  |                               | 140ns                     | MISO tri-state to valid data from clock positive edge                        |
| D12  |                               | 300ns                     | MISO valid data to tri-state from SPI_CS positive edge                       |
| D13  | 1 SPI clock cycles            |                           | SPI_CS width (Delay eSPI1 frame to adjacent eSPI1 frame)                     |
| D14  |                               | 60ns                      | Filtered Glitch Width  |
| D15  | D3 + 15.5 SPI clock<br>cycles | D3+23.75 SPI clock cycles | MISO tri-state from SPI_CS Negative Edge to valid data                       |



### **DATASHEET**



| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
| DIW | MIN         | MAX  | MIN       | MAX   |
| Α   | 0.80        | 1.00 | 0.031     | 0.039 |
| A1  | 0.00        | 0.05 | 0         | 0.002 |
| A3  | 0.20 REF    |      | 0.008 REF |       |
| K   | 0.20 MIN    |      | 0.008 MIN |       |
| е   | 0.50 BSC    |      | 0.02 BSC  |       |
| L   | 0.30        | 0.50 | 0.012     | 0.02  |
| b   | 0.18        | 0.30 | 0.007     | 0.012 |
| D2  | 6.35        | 6.60 | 0.250     | 0.260 |
| E2  | 6.35        | 6.60 | 0.250     | 0.260 |
| D   | 8.00 BSC    |      | 0.315 BSC |       |
| Е   | 8.00 BSC    |      | 0.315 BSC |       |

### Note:

Dimensions do not include protrusions; these do not exceed 0.155 mm (.006") on any side. Lead dimension do not include solder coverage.



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# PD69108 Internal Block Diagram

The PD69108 is based on two major sections:

- A Digital section which controls and monitors the logical PoE functions (state machines, timings etc.)
- An Analog section which performs the Front End analog PoE functionality.

Figure 1 illustrates both functions.

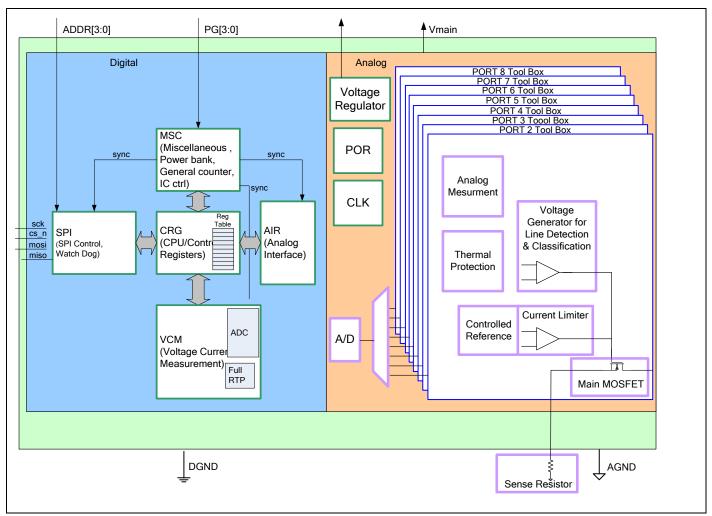


Figure 1: PD69108 Internal Block Diagram



### **Logic Main Control Module**

The Logic Main Control Block includes the Digital Timing Mechanisms and State Machines synchronizing and activating PoE functions according to MCU control commands such as:

- Real Time Protection (RTP)
- Start Up Macro (DVDT)
- Load Signature Detection (RES DET)
- Classification Macro (CLASS)
- Voltage and Current Monitoring Registers (VMC)
- ADC Interfacing
- Direct Digital Signals with Analog Block

### **Line Detection Generator**

Upon request from the MCU to the Main Control Module, four different voltage levels are generated by the Line Detection Generator to ensure a robust AF / AT Line Detection functionality.

### **Classification Generator**

Upon request from the MCU to the Main Control Module, the State Machine applies a regulated Class Event and Mark Event voltage to the ports, as required by the IEEE standard.

### **Current Limiter**

This circuit continuously monitors the current of powered ports and limits the current to a specific value, according to pre-defined limits as set by AF/AT and Current\_Set pins. In cases where the current exceeds this specific level, the system starts measuring the elapsed time. If this time period is greater than a preset threshold, the port is disconnected.

### **Main MOSFET**

Main power switching FET, used to control PoE current into the load.

#### **ADC**

A 10-Bit Analog to Digital converter, used to convert analog signals into digital registers for the Logic Control module.

### Power on Reset (POR)

Monitors the internal 3.3 V voltage DC levels; if this voltage drops below specific thresholds, a reset signal is generated and the PD69108 is reset.

### 8 PORTS PSE POE MANAGER

### **DATASHEET**

### **Voltage Regulator**

The voltage regulator generates 3.3 VDC and 5 VDC for the internal circuitry. These voltages are derived from the Vmain supply.

To use the internal voltage regulator connect:

- VAUX5 to DRV VAUX5
- VAUX3P3 to VAUX3P3 INT
- REG EN N to AGND.

There are two options to reduce the PD69108 power dissipation by regulating the voltage outside the chip:

 Use an external NPN transistor to regulate the 5 VDC.

In this setup, the configuration of the regulators pins should be:

- DRV\_VAUX5 is connected to the NPN BASE
- VAUX5 is connected to the NPN EMITTER (Connect the **Collector** to VMAIN)
- VAUX3P3 is connected to VAUX3P3\_INT
- REG EN N is connected to AGND
- Supply the PD69108 with an external 3.3 V voltage regulator.

In this setup, the configuration of the regulators pins should be:

- VAUX5 is connected to DRV VAUX5
- VAUX3P3 INT is connected to VAUX5
- VAUX3P3 is connected to the external 3.3 V
- REG EN N is connected to VAUX3P3

The above two options can be implemented simultaneously.

### CLK

CLK is an internal 8 MHz clock oscillator.



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# **Theory of Operation**

The PD69108 performs IEEE802.3af and IEEE802.3at functionality as well as legacy (capacitor) and Cisco's PDs detection and additional protections such as short circuit and dV/dT protection upon startup.

### **Line Detection**

The Line Detection feature detects a valid AF or AT load, as specified in the AF / AT standard. The resistor value should go from 19 k $\Omega$  to 26.5 k $\Omega$ . Line detection is based on four different voltage levels generated over the PD (the load) as illustrated in Figure 2.

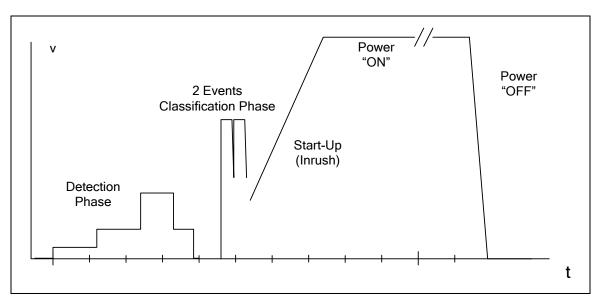


Figure 2: Typical PoE Voltage Time Diagram

### Legacy (Cap) Detection

In cases where **legacy** is set, the PD69108's Detection mechanism detects and powers up legacy PDs as well as AF/AT compliant PDs.

This mechanism is designed to detect and power up CISCO legacy PDs as well.

### Classification

The classification process takes place immediately after resistor detection has successfully completed. The goal of the classification process is to detect PD class, as specified in the IEEE802.3AF and AT standards.

In the AF mode, classification mechanism is based on a single voltage level (single finger).

In the AT mode, classification mechanism is based on two voltage levels (dual finger) as defined in IEEE802.3at-2009.

### **Port Start Up**

Upon a successful detection and classification process, power is applied to the load via a controlled Start Up mechanism.

During this period current is limited to 425 mA for a typical duration of 65 mS, which allows the PD load to charge and allow steady state power condition.

### Over-Load Detection and Port Shut Down

After power up, the PD69108 automatically initializes its internal protection mechanisms utilized to monitor and disconnect power from the load in cases where extreme conditions such as over-current or short ports terminals scenario occur, as specified in the IEEE802.3AF/AT standard.

#### **Disconnect Detection**

The PD69108 supports DC Disconnect Function as per the IEEE802.3AF/AT standard.

This mechanism continuously monitors load current and disconnects power in cases where load current is below 7.5 mA (typical) for more than 322 mS.

### **Over-Temperature Protection**

The PD69108 has internal temperature sensors that continuously monitor the main MOSFET junction temperature and disconnect load power in cases where



junction temperature exceeds 200° C. This mechanism protects the device from extreme events, such as high ambient temperature or other thermo-mechanical failures that could damage the PD69108.

### 8 PORTS PSE POE MANAGER

#### **DATASHEET**

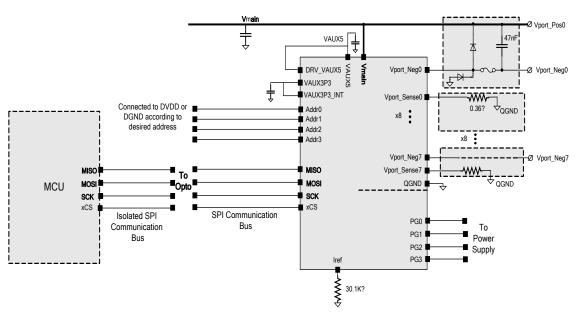
### **V<sub>MAIN</sub>** Out of Range Protection

The PD69108 automatically disconnects port power in cases where Vmain exceeds 60 VDC. This valuable mechanism protects the load in cases where main power source is faulty or damaged.

### TYPICAL APPLICATION

This typical application illustrates a simple Power Over Ethernet system Solution for an 8 Ethernet Ports Switch or

"POS" and "NEG" Signals should be connected to the Switch RJ45 Jack



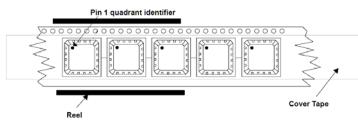
**Figure 3: Typical Application** 

\* For detailed application's schematics and layout recommendations, contact: <a href="mailto:sales\_AMSG@microsemi.com">sales\_AMSG@microsemi.com</a>



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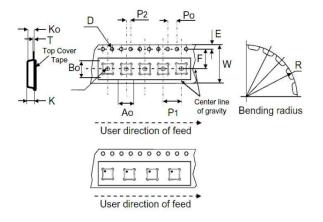
### Tape and Reel - Packaging Information



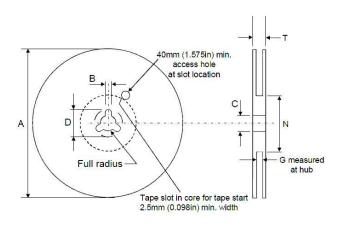
Pin-1 Orientation of QFN Packages

| REEL MECHANICAL DATA |               |                  |  |  |  |
|----------------------|---------------|------------------|--|--|--|
|                      | mm.           | inch             |  |  |  |
| Tape size            | 16.00 ±0.3    | 0.630 ±0.012     |  |  |  |
| A max.               | 330           | 13"              |  |  |  |
| B max.               | 1.5           | 0.059            |  |  |  |
| С                    | 13.0 ±0.20    | 0.512 ±0.008     |  |  |  |
| D min.               | 20.2          | 0.795            |  |  |  |
| N min.               | 50            | 1.968            |  |  |  |
| G                    | 16.4+2.0/-0.0 | 0.645+0.079/-0.0 |  |  |  |
| T max.               | 29            | 1.142            |  |  |  |
| BASE QUANTITY        | 2000 pcs.     |                  |  |  |  |

TAPE & REEL SHIPMENT INFORMATION
TAPE SPECIFICATIONS



# TAPE & REEL SHIPMENT INFORMATION REEL SPECIFICATIONS





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#### Revision History

| Revision Level / | Para. Affected | Description  |
|------------------|----------------|--|
| Date             |                |  |
| 0.1 / 3-Nov-09   | -              | Initial Release  |
| 0.2 / 10-Jan-10  |                | Power Dissipation  |
| 0.3 / 12-Apr-10  |                | Update   |
| 0.4 / 12-May-10  |                | Ordering information update                              |
| 0.4/ 27-Jul-10   |                | Changing catalog numbers metrology                       |
| 0.5/10-Apr-11    |                | Update/corrections                                       |
| 0.6/1-Aug-11     |                | Add SPI Timing Data                                      |
| 1.2/Oct 2011     |                | Add Theta JC   |
| 1.3/Jan 2012     |                | Remove "Confidential" header and updating Footer address |
| 1.4/Feb 2012     |                | Updating I lim according to UL and IEEE                  |
| 1.5/Dec 2012     |                | Adding Tape & Reel Data                                  |
| 1.6/March 2013   |                | Adding full temperature rang P/N                         |

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